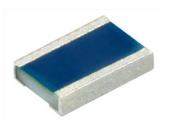


Vishay Beyschlag

Precision Wide Terminal Thin Film Chip Resistors



MCW 0406 AT Precision Wide Terminal Resistors are the perfect choice for most fields of modern professional power measurement electronics where reliability, stability, power dissipation, and robust design is of major concern.

Beside extremely high power ratings, the MCW 0406 AT is characterized by extraordinary temperature cycling robustness, verified through extensive testing.

The permissible power rating is specified with 250 mW. Typical applications include power electronics in automotive and industrial appliances.

FEATURES

- Rated dissipation P₇₀ up to 250 mW
- Resistance range down to 1R



- Operating temperature up to 155 °C
- AEC-Q200 qualified (pending)
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Automotive
- Industrial
- High power applications
- Replacement for larger case sizes

TECHNICAL SPECIFICATIONS				
DESCRIPTION	MCW 0406 AT			
Imperial size	0406			
Metric size code	RR1016M			
Resistance range	1 Ω to 100 kΩ			
Resistance tolerance	± 0.1 %			
Temperature coefficient	± 15 ppm/K; ± 25 ppm/K			
Rated dissipation P ₇₀ ⁽¹⁾	0.25 W			
Operating voltage, U _{max.} AC/DC	50 V			
Permissible film temperature, 9 _F max. (1)	155 °C			
Operating temperature range (1)	- 55 °C to 155 °C			
Insulation voltage				
1 min; U _{ins}	75 V			
Continuous	75 V			
Failure rate: FIT _{observed}	To be established			

Note

(1) Please refer to APPLICATION INFORMATION, see next page.



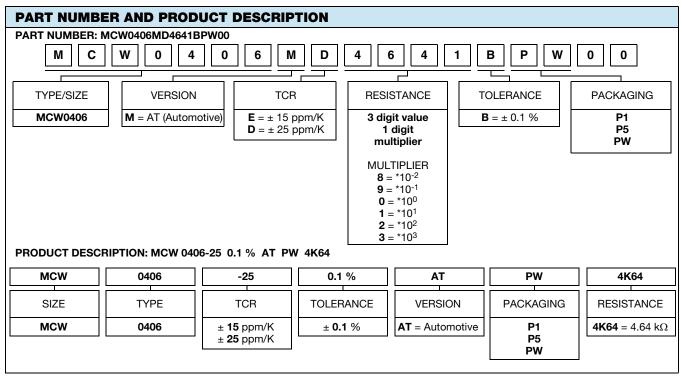
Vishay Beyschlag

APPLICATION INFORMATION

The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature is not exceeded. Furthermore, a high level of ambient temperature or of power dissipation may raise the temperature of the solder joint, hence special solder alloys or board materials may be required to maintain the reliability of the assembly.

These resistors do not feature a lifetime limitation when operated within the limits of rated dissipation, permissible operating voltage and permissible film temperature. However, the resistance typically increases due to the resistor's film temperature over operating time, generally known as drift. The drift may exceed the stability requirements of an individual application circuit and thereby limits the functional lifetime. The designer may estimate the performance of the particular resistor application or set certain load and temperature limits in order to maintain a desired stability.

MAXIMUM RESISTANCE CHANGE AT RATED DISSIPATION					
OPERATION MODE	STANDARD	POWER			
Rated dissipation	P ₇₀	P ₇₀			
MCW 0406 AT	0.200 W	0.250 W			
Applied maximum film temperature, θ_{F} max.	125 °C	155 °C			
Max. resistance change at rated dissipation for resistance range:					
MCW 0406 AT	1 Ω to 100 kΩ	1 Ω to 100 k Ω			
$ \Delta R/R $ max., after:					
1000 h	≤ 0.1 %	≤ 0.2 %			
8000 h	≤ 0.2 %	≤ 0.4 %			
225 000 h	≤ 0.6 %	-			



Note

• Products can be ordered using either the PART NUMBER or PRODUCT DESCRIPTION.



Vishay Beyschlag

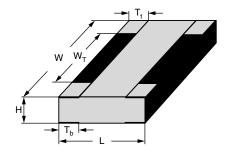
TEMPERATURE COEFFICIENT AND RESISTANCE RANGE					
DESCR	DESCRIPTION RESISTANCE				
TCR	TOLERANCE	MCW 0406 AT			
± 25 ppm/K	± 0.1 %	1 Ω to 100 k Ω			
± 15 ppm/K	± 0.1 %	47 Ω to 100 k Ω			

Note

• Resistance values are available from the E96 and E192 series, other values are available on request.

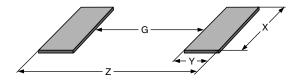
PACKAGING							
TYPE	CODE	QUANTITY	CARRIER TAPE	WIDTH	PITCH	REEL DIAMETER	
	P1	1000	Tape and reel			180 mm/7"	
MCW 0406 AT	P5	5000	cardboard tape acc.	8 mm	4 mm	100 111111/1	
	PW	20 000	IEC 60286-3 Type I			330 mm/13"	

DIMENSIONS



DIMENSIONS AND MASS							
TYPE	H (mm)	L (mm)	W (mm)	W _T (mm)	T _t (mm)	T _b (mm)	MASS (mg)
MCW 0406 AT	0.3 ± 0.05	1.0 ± 0.15	1.5 ± 0.15	> 75 % of W	0.2 + 0.1/- 0.15	0.2 ± 0.1	1.9

SOLDER PAD DIMENSIONS



RECOMMENDED SOLDER PAD DIMENSIONS						
		OLDERING				
TYPE	G (mm)	Y (mm)	X (mm)	Z (mm)		
MCW 0406 AT	0.35 0.55 1.75 1.45					

Note

The rated dissipation applies only if the permitted film temperature is not exceeded. Furthermore, a high level of ambient temperature or of
power dissipation may raise the temperature of the solder joint, hence special solder alloys or boardmaterials may be required to maintain
the reliability of the assembly. Specified power rating above 125 °C requires dedicated heat-sink pads, which to a great extend depends on
board materials and design.

The given solder pad dimensions reflect the considerations for board design and assembly as outlined e.g. in standards IEC 61188-5-x, or in publication IPC-7351. They do not guarantee any supposed thermal properties, particularly as these are also strongly influenced by many other parameters.

Still, the given solder pad dimensions will be found adequate for most general applications, e.g. those referring to "standard operation mode". Please note however that applications for "power operation mode" or "advanced temperature mode" require special considerations for the design of solder pads and adjacent conductor areas.

MCW 0406 AT - Precision



Vishay Beyschlag

DESCRIPTION

Production is strictly controlled and follows an extensive set of instructions established for reproducibility. A homogeneous film of special metal alloy is deposited on a high grade ceramic substrate (Al_2O_3) and conditioned to achieve the desired temperature coefficient. Specially designed inner contacts are deposited on both sides. A special laser is used to achieve the target value by smoothly cutting a meander groove in the resistive layer without damaging the ceramics. The resistor elements are covered by a unique protective coating designed for electrical, mechanical and climatic protection. The terminations receive a final pure tin on nickel plating.

The result of the determined production is verified by an extensive testing procedure and optical inspection performed on 100 % of the individual chip resistors. This includes full screening for the elimination of products with potential risk of early field failures (feasible for R \geq 10 Ω). Only accepted products are laid directly into the paper tape in accordance with **IEC 60286-3** ⁽¹⁾.

ASSEMBLY

The resistors are suitable for processing on automatic SMD assembly systems. They are suitable for automatic soldering using reflow or vapour phase as shown in **IEC 61760-1** ⁽¹⁾. The encapsulation is resistant to all cleaning solvents commonly used in the electronics industry, including alcohols, esters and aqueous solutions. The suitability of conformal coatings, if applied, shall be qualified by appropriate means to ensure the long-term stability of the whole system.

The resistors are RoHS compliant; the pure tin plating provides compatibility with lead (Pb)-free and lead-containing soldering processes. Solderability is specified for 2 years after production or requalification. The permitted storage time is 20 years. The immunity of the plating against tin whisker growth has been proven by extensive testing.

All products comply with the **GADSL** ⁽²⁾ and the **CEFIC-EECA-EICTA** ⁽³⁾ list of legal restrictions on hazardous substances. This includes full compliance with the following directives:

- 2000/53/EC End of Vehicle life Directive (ELV) and Annex II (ELV II)
- 2011/65/EU Restriction of the use of Hazardous Substances directive (RoHS)
- 2002/96/EC Waste Electrical and Electronic Equipment Directive (WEEE)

APPROVALS

Where applicable the resistors are tested within the IECQ-CECC Quality Assessment System for Electronic Components to the detail specification EN 140401-801 which refers to EN 60115-1, EN 140400 and the variety of environmental test procedures of the IEC 60068 ⁽³⁾ series. The detail specification refers to the climatic categories 55/125/56, which relates to the "standard operation mode" of this datasheet.

Vishay BEYSCHLAG has achieved "Approval of Manufacturer" in accordance with IECQ 03-1. The release certificate for "Technology Approval Schedule" in accordance with CECC 240001 based on IECQ 03-3, is granted for the Vishay BEYSCHLAG manufacturing process.

The qualification of the MCW 0406 AT - Precision according to AEC-Q200 is pending.

RELATED PRODUCTS

For an alternative range of TCR and tolerance see the datasheet:

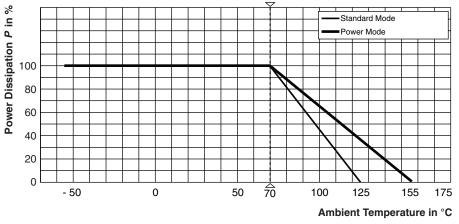
 Professional Wide Terminal Thin Film Chip Resistors (www.vishay.com/doc?28796)

Notes

- (1) The quoted IEC standards are also released as EN standards with the same number and identical contents.
- (2) Global Automotive Declarable Substance List, see www.gadsl.org.
- (3) CEFIC (European Chemical Industry Council), EECA (European Electronic Component Manufacturers Association), EICTA (European trade organisation representing the information and communications technology and consumer electronics), see www.eicta.org → issues → environment policy → chemicals → chemicals for electronics.

Vishay Beyschlag

FUNCTIONAL PERFORMANCE



Derating

Note

• For the permissible resistance change in each operation mode please refer to table MAXIMUM RESISTANCE CHANGE AT RATED DISSIPATION, above.

TESTS AND REQUIREMENTS

All tests are carried out in accordance with the following specifications:

EN 60115-1, generic specification

EN 140400, sectional specification

EN 140401-801, detail specification

The testing also covers most of the requirements specified by EIA/IS-703 and JIS-C-5202.

The tests are carried out under standard atmospheric conditions in accordance with IEC 60068-1, 5.3. Climatic category LCT/UCT/56 (rated temperature range: Lower category temperature, upper category temperature; damp heat, long term, 56 days) is valid (LCT = - 55 °C/UCT = 125 °C).

Unless otherwise specified the following values apply:

Temperature: 15 °C to 35 °C Relative humidity: 45 % to 75 %

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar).

The components are mounted for testing on boards in accordance with EN 140400, 2.3.3 unless otherwise specified.

The requirements stated in the Test Procedures and Requirements table are based on the required tests and permitted limits of EN 140401-801. However, some additional tests and a number of improvements against those minimum requirements have been included.



Vishay Beyschlag

EN 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (Δ <i>R</i>)
	•		Stability for product types:	
	_		MCW 0406 AT	1 Ω to 100 k Ω
4.5	-	Resistance		± 0.1 % R
4.8.4.2	-	Temperature coefficient	At (20/- 55/20) °C and (20/155/20) °C	± 15 ppm/K; ± 25 ppm/K
4.25.1	_	Endurance at 70 °C: Standard operation mode	$U = \sqrt{P_{70} \times R}$ or $U = U_{\text{max.}}$; whichever is the less severe; 1.5 h on; 0.5 h off; 70 °C; 1000 h 70 °C; 8000 h	$\pm (0.1 \% R + 0.02 \Omega)$ $\pm (0.2 \% R + 0.02 \Omega)$
4.20.1		Endurance at 70 °C: Power operation mode	$U = \sqrt{P_{70} \times R} \text{ or } U = U_{\text{max.}};$ whichever is the less severe; $1.5 \text{ h on; } 0.5 \text{ h off;}$ $70 \text{ °C; } 1000 \text{ h}$ $70 \text{ °C; } 8000 \text{ h}$	\pm (0.2 % R + 0.02 Ω) \pm (0.4 % R + 0.05 Ω)
4.25.3	-	Endurance at upper category temperature	125 °C; 1000 h 155 °C; 1000 h	$\pm (0.15 \% R + 0.02 \Omega)$ $\pm (0.3 \% R + 0.05 \Omega)$
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; 56 days; (93 ± 3) % RH	$\pm (0.1 \% R + 0.02 \Omega)$
4.39	67 (Cy)	Damp heat, steady state, accelerated: Standard operation mode	(85 ± 2) °C (85 ± 5) % RH $U = \sqrt{0.1 \times P_{70} \times R}$; $U \le 0.3 \times U_{\text{max.}}$; 1000 h	$\pm (0.5 \% R + 0.05 \Omega)$
4.23		Climatic sequence: Standard operation mode:		
4.23.2	2 (Bb)	Dry heat	125 °C; 16 h	
4.23.3	30 (Db)	Damp heat, cyclic	55 °C; 24 h; > 90 % RH; 1 cycle	
4.23.4	1	Cold	- 55 °C; 2 h	$\pm (0.25 \% R + 0.05 \Omega)$
4.23.5	13 (M)	Low air pressure	8.5 kPa; 2 h; (25 ± 10) °C	
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; 24 h; > 90 % RH; 5 cycles	
4.23.7	-	DC load	$U = \sqrt{P_{70} \times R} \le U_{\text{max.}}$; 1 min	
-	1 (Ab)	Storage at low temperature	- 55 °C; 2 h	$\pm (0.05 \% R + 0.01\Omega)$
4.19	14 (Na)	Rapid change of temperature	30 min at - 55 °C and 30 min at 155 °C; 1000 cycles	$\pm (0.25 \% R + 0.05 \Omega)$
4.13	-	Short time overload: Standard operation mode	$U = 2.5 \times \sqrt{P_{70} \times R}$ $\leq 2 \times U_{\text{max}};$ whichever is the less severe; 5 s	± (0.05 % R + 0.01Ω)
4.27	-	Single pulse high voltage overload: Standard operation mode	Severity no. 4: $U = 10 \times \sqrt{P_{70} \times R}$ or $U = 2 \times U_{\text{max.}}$; whichever is the less severe; 10 pulses 10 µs/700 µs	To be determined
4.37	-	Periodic electric overload: Standard operation mode	$U = \sqrt{15 \times P_{70} \times R} \text{ or } $ $U = 2 \times U_{\text{max.}}$ whichever is the less severe; 0.1 s on; 2.5 s off; 1000 cycles	To be determined





Vishay Beyschlag

TEST PI	TEST PROCEDURES AND REQUIREMENTS					
EN 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)		
			Stability for product types:			
			MCW 0406 AT	1 Ω to 100 kΩ		
4.40	-	Electro Static Discharge (Human Body Model)	IEC 61340-3-1; 3 pos. + 3 neg. (equivalent to MIL-STD-883, method 3015) 500 V	± (0.5 % R + 0.05 Ω)		
4.22	6 (Fc)	Vibration	Endurance by sweeping; 10 Hz to 2000 Hz; no resonance; amplitude ≤ 1.5 mm or ≤ 200 m/s²; 7.5 h	\pm (0.05 % R + 0.01 Ω) no visible damage		
			Solder bath method; SnPb40; non-activated flux (215 ± 3) °C; (3 ± 0.3) s	Good tinning (≥ 95 % covered); no visible damage		
4.17.2	58 (Td)	Solderability	Solder bath method; SnAg3Cu0.5 or SnAg3.5; non-activated flux; (235 ± 3) °C; (2 ± 0.2) s	Good tinning (≥ 95 % covered); no visible damage		
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method; (260 ± 5) °C; (10 ± 1) s	\pm (0.1 % R + 0.02 Ω) no visible damage		
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol + 50 °C; method 2	No visible damage		
4.32	21 (Ue ₃)	Shear (adhesion)	RR 1016M; 9 N	No visible damage		
4.33	21 (Ue ₁)	Substrate bending	Depth 2 mm, 3 times	$ \pm (0.05~\%~R + 0.01~\Omega) $ no visible damage; no open circuit in bent position		
4.7	-	Voltage proof	$U_{RMS} = U_{ins}$; (60 ± 5) s	No flashover or breakdown		
4.35	-	Flammability	Needle flame test; 10 s	No burning after 30 s		



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Revision: 02-Oct-12 Document Number: 91000



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов:
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001:
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина,

дом 2, корпус 4, литера А.